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m PTO-1595 (Rev. 03-11)	U.S. DEPARTMENT OF COMMERCE United States Patent and Trademark Office
MB No. 0651-0027 (exp. 03/31/2012) RECORDATION FOR	
PATENTS	
To the Director of the U.S. Patent and Trademark Office: Please	record the attached documents or the new address(es) below.
1. Name of conveying party(ies):	2. Name and address of receiving party(les)
Naokl Miyabayashi (12/19/2011) and Masahiro	Name: Sony Corporation
Sueyoshi (12/20/2011)	Internal Address:
Additional name(s) of conveying party(les) attached?	Street Address:
3. Nature of conveyance/Execution Date(s):	1-7-1 Konan, Minato-ku Talaca
Execution Date(s): in parentheses after inventor name	108-0075
X Assignment Merger Change of Name	JAPAN
Security Agreement	City:
Government Interest Assignment	State:
Executive Order 9424, Confirmatory License	Country:Zip;
	Additional name(s) & address(05) Yes X No ettached?
4. Application or patent number(s):	This document is being filed together with a new application.
A. Patent Application No.(s)	B. Patent No.(s)
13/355,992	
Additional numbers attached	
5. Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and 1 patents involved:
Name: Dennis M. Smid, Esq. LERNER, DAVID, LITTENBERG,	
KRUMHOLZ & MENTLIK, LLP	7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00
Internal Address: Atty, Dkt.: SONYJP 3.0-2693 Street Address: 600 South Avenue West	
	X Authorized to be charged to deposit account
	None required (government Interest not affecting title
City: Westfield	8. Payment Information
State: NJ Zip: 07090	
Phone Number: 908-654-5000	
Fax Number:908-654-7866	_ Deposit Account Number 12-1095 Authorized User Name Dennis M. Smid, Esq.
Email Address:ataylor@Idikm.com	
9. Signature:	January 23, 2012
Signature	Date
Dennis M. Smid, Esq 34,930 Name of Person Signing	Total number of pages Including cover 2 sheet, attechments, and documents:

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1590138

Attorney Docket No. SONYJP 3.0-2693 SONY Ref. No.: \$12P0122US00

REEL: 027579 FRAME: 0999

## ASSIGNMENT

WHERPAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in INFORMATION PROCESSING APPARATUS, METHOD, AND PROGRAM

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY CORPORATION, a Japanese corporation, with offices at 1-7-1 Konan, Minata-ku, Tokyo, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and In and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and In and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignce of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number:  $\frac{13/355,992}{13/355,992}$ , Filing Date:  $\underline{January 23, 2012}$ .

This assignment executed on the dates indicated below.

NAOKI MIYABAYASHI		
Name of first or sole inventor	•	Execution date of U.S. Patent Application
TOKYO JAPAN		·
Residence of First or sole inventor		
Naoki Mixabarashi		December 19, 2011 Date of this assignment
Signature of first of sole inventor	-	Date of this assignment
MASAHIRO SUEYOSHI		
Name of second inventor		Execution date of U.S. Patent Application
KANAGAWA JAPAN		
Residence of second inventors		<b>N</b> 1 <b>N</b> 1 1
masafurd Sucyostu		December 20,2011_
Signature of second inventor		Date of this assignment
Name of third inventor		Execution date of U.S. Patent Application
		Exponent out of o.s. ration repriorition
Residence of third inventor		
Signature of third inventor		Date of this assignment
-		
	1	
		PATENT

**RECORDED: 01/23/2012**